Serial No. 10/790,412 Attorney Docket No. H1648 Firm Reference No. AMDSPH1648US Reply to Office Action Dated August 5, 2004 Reply Dated October 28, 2004

AMENDMENTS IN THE CLAIMS:

This listing of claims will replace all prior versions, and listings, of claims in the application: Listing of Claims:

1. (Currently Amended) A method of preventing contamination in a lithographic apparatus including a projection system, comprising:

providing the lithographic apparatus including the projection system for imaging an irradiated portion of a mask onto a target portion of a substrate; and

placing a pellicle over a surface of the projection system to inhibit contamination of the surface,

wherein the placing of the pellicle is accomplished by a moveable mounting means that translates into the lithographic apparatus in order to position the pellicle in close proximity to the surface of the projection system.

- 2. (Currently Amended) The method of claim 1, wherein the pellicle comprises a flourine fluorine polymer.
 - 3. (Original) The method of claim 1, wherein the pellicle comprises a fused silica.
- (Original) The method of claim 1, including the step of:
 replacing the pellicle when a scattering of an illumination source reaches a specified
 criteria.
- (Original) The method of claim 1, including the step of:
 illuminating the lithographic apparatus with an illumination light of a wavelength of between about 190 nm and 250 nm.
- 6. (Original) The method of claim 1, including the step of: illuminating the lithographic apparatus with an illumination light of a wavelength of between about 155 nm and 190 nm.
- 7. (Original) The method of claim 1, wherein the surface of the projection system is at least one of a top surface and bottom surface.

Serial No. 10/790,412 Attorney Docket No. H1648 Firm Reference No. AMDSPH1648US Reply to Office Action Dated August 5, 2004 Reply Dated October 28, 2004

- 8. (Original) The method of claim 2, wherein the surface is the top surface of the projection system.
- 9. (Original) The method of claim 1, wherein the surface is the bottom surface of the projection system.
- 10. (Original) The method of claim 3, wherein the projection system includes at least two lenses,

the top surface of the projection system is a top surface of a top lens, and the bottom surface of the projection system is a bottom surface of a bottom lens.

11. (Currently Amended) A lithographic apparatus, comprising:

a projection system for imaging an irradiated portion of a mask onto a target portion of a substrate; and

a pellicle placed over a surface of the projection system to inhibit contamination of the surface, and

a moveable mounting means that translates into the lithographic apparatus in order to position the pellicle in close proximity to the surface of the projection system.

- 12. (Currently Amended) A lithographic apparatus according to claim 11, wherein the pellicle comprises a flourine fluorine polymer.
- 13. (Original) A lithographic apparatus according to claim 11, wherein the pellicle comprises a fused silica.
- 14. (Original) A lithographic apparatus according to claim 11, wherein the pellicle is replaceable.
 - 15. (Original) A lithographic apparatus according to claim 11, including: an illumination light of a wavelength of between about 190 nm and 250 nm.

Serial No. 10/790,412 Attorney Docket No. H1648 Firm Reference No. AMDSPH1648US Reply to Office Action Dated August 5, 2004 Reply Dated October 28, 2004

- 16. (Original) A lithographic apparatus according to claim 11, including: an illumination light of a wavelength of between about 155 nm and 190 nm.
- 17. (Original) A lithographic apparatus according to claim 11, wherein the surface of the projection system is at least one of a top surface and bottom surface.
- 18. (Original) A lithographic apparatus according to claim 17, wherein the surface is the top surface of the projection system.
- 19. (Original) A lithographic apparatus according to claim 17, wherein the surface is the bottom surface of the projection system.
- 20. (Original) A lithographic apparatus according to claim 17, wherein the projection system includes at least two lens,

the top surface of the projection system is a top surface of a top lens, and the bottom surface of the projection system is a bottom surface of a bottom lens.

21. (Currently Amended) A lithographic apparatus comprising:

a radiation system for supplying a projection beam of radiation;

a mask table including a mask holder for holding a mask connected to a positioner for accurately positioning the mask with respect to a projection system;

a substrate table including a substrate holder for holding a substrate connected to the positioner for accurately positioning the substrate with respect to the projection system; and

a pellicle placed over a surface of the projection system to inhibit contamination of the surface; and

a moveable mounting means that translates into the lithographic apparatus in order to position the pellicle in close proximity to the surface of the projection system.

the projection system for imaging an irradiated portion of the mask onto a target portion of the substrate.